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## **Supplementary Information**

## Constructing low-cost and high-strength ultra-low-density proppants based on the modification of activated carbon framework with in-situ hydrolyzed silane

Zhen Zeng<sup>a</sup>, Shiqiang Wang<sup>a</sup>, Ermei Liu<sup>b</sup>, Wei Qin<sup>a</sup>, Yang Zhou<sup>a</sup>, Zhenyong Li<sup>a</sup>, Yu Song<sup>a</sup>, Min Xu<sup>a</sup>, Fuli Bian<sup>b\*</sup>, Xianyan Ren<sup>a\*</sup>

(<sup>a</sup>School of Materials and Chemistry, Southwest University of Science and Technology, Mianyang 621010, China; <sup>b</sup>Cooper (Ningbo) Electric Co, Ningbo, Zhejiang 315000, China;

<sup>c</sup>Shanghai Fire Research Institute of MEM, Shanghai 200032, People's Republic of China)

\* Corresponding author: The corresponding authors contribute equally to this work.

E-mail address: renxianyan@swust.edu.cn; bianfuli@shfri.cn.

Tab.S1. The molecular weight distribution of thermosetting phenolic resins (PFNH-230).											
Peak No	Mp	Mn	Mw	Mz	Mz+1	Mv	PD				
1	1798	2515	7861	22579	46266	6532	3.12565				
2	533	444	476	506	532	472	1.07207				
3	174	168	175	183	190	174	1.04167				

Tab.S2. The viscosity of KH570 and PF.								
Sample Rotor		rotation	viscosity (mPa.S)	Angle				
		speed (rad/min)						
KH570	Rotor 0	60	2.2	23.7%				
PF/ethanol solution	Rotor 0	60	3.2	33.2%				



Fig. S1. The volume shrinkage comparison chart of phenol-formaldehyde resin and KH570. (a): Before curing of PF. (b): After curing of PF. (c): Before hydrolysis of KH570. (d): After hydrolysis of KH570.